

Extend the pads on L5 so that the footprint could accommodate either the Murata part or the TDK ADL series part

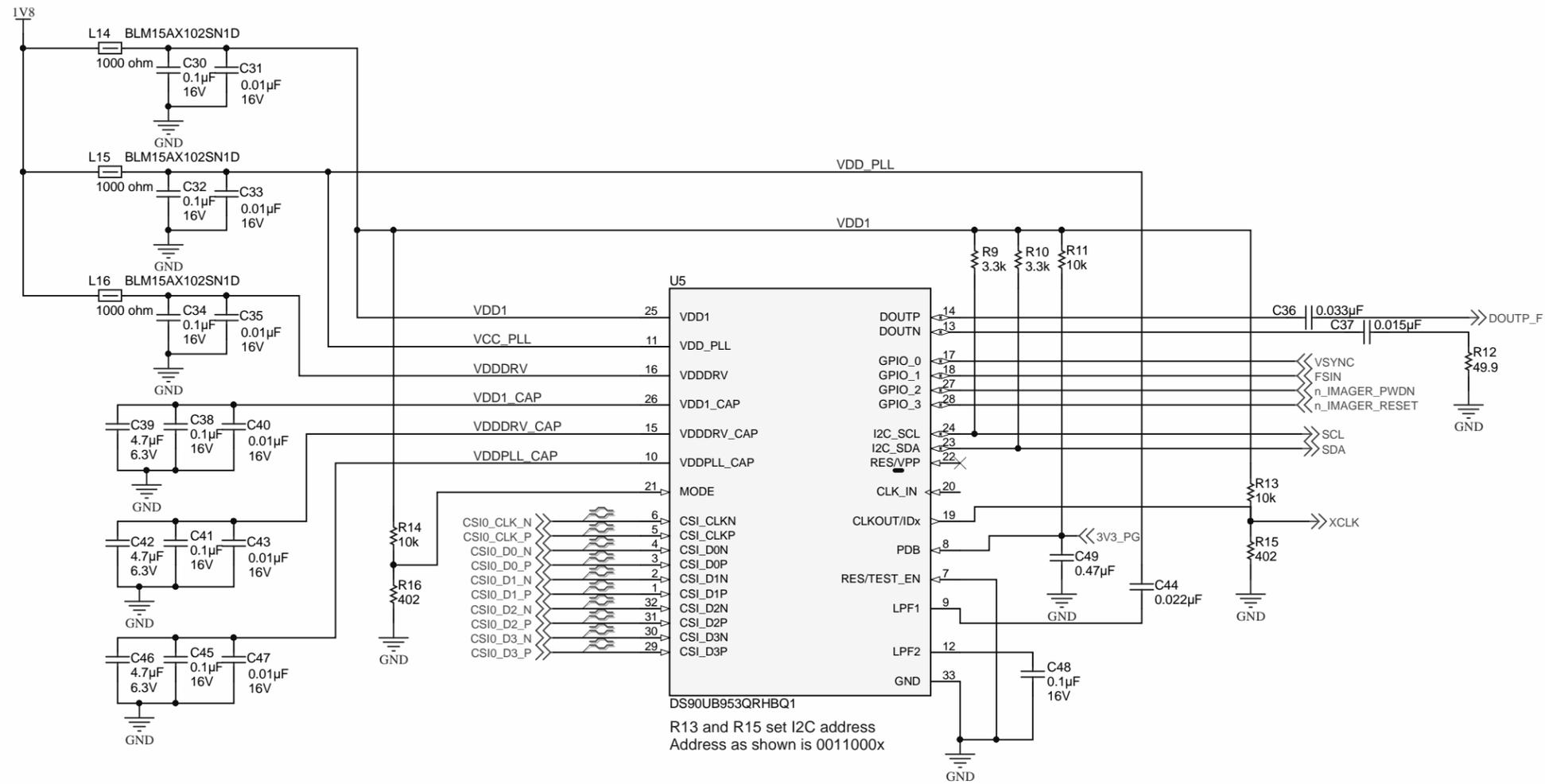
COAX CONNECTOR, POWER SUPPLY

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Number: TIDA-01130	Rev: E3	Designed for: Public Release	Mod. Date: 10/16/2017
SVN Rev: Not in version control		Project Title: TIDA-01130	
Drawn By: Brian Shaffer		Sheet Title: Coax Connector and Power Supply	
Engineer: Shaffer & Bianchi		Assembly Variant: 001	Sheet: 1 of 4
		File: Coax Connection and Power Supply.SchDoc	Size: B
		Contact: http://www.ti.com/support	



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SERIALIZER

Designed for: Public Release	Mod. Date: 10/16/2017
Project Title: TIDA-01130	
Number: TIDA-01130	Rev: E3
SVN Rev: Not in version control	Sheet Title: Serializer
Drawn By: Brian Shaffer	Assembly Variant: 001
Engineer: Shaffer & Bianchi	File: Serializer.SchDoc
	Sheet: 3 of 4
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LH1
MECH
CMT821



ZZ1

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

PCB Number: TIDA-01130
PCB Rev: E3

A

A

B

B

C

C

D

D

Hardware

Designed for: Public Release		Mod. Date: 10/16/2017	
Project Title: TIDA-01130			
Number: TIDA-01130		Rev: E3	
SVN Rev: Not in version control		Sheet Title: Hardware	
Drawn By: Brian Shaffer		Assembly Variant: 001	
Engineer: Shaffer & Bianchi		File: HDWR.SchDoc	
		Sheet: 4 of 4	
		Size: B	
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